COMPLIANT HALOGEN **FREE**



N-Channel 30-V (D-S) MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	$R_{DS(on)}\left(\Omega\right)$ $I_{D}\left(A\right)$		Q _g (Typ.)		
30	0.023 at $V_{GS} = 10 \text{ V}$	8			
	0.025 at V _{GS} = 4.5 V	7.5	6.5		
	0.030 at V _{GS} = 3.0 V	6.8	0.5		
	0.036 at V _{GS} = 2.5 V	6.0			

SO-8 D S D D Top View

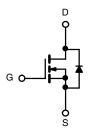
Ordering Information: Si4346DY-T1-E3 (Lead (Pb)-free) Si4346DY-T1-GE3 (Lead (Pb)-free and Halogen-free)

FEATURES

- Halogen-free According to IEC 61249-2-21 Available
- TrenchFET® Gen II Power MOSFET
- 100 % R_g Tested

APPLICATIONS

- High-Side DC/DC Conversion
 - Notebook
 - Desktop
 - Server
- Notebook Logic DC/DC, Low-Side



N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS T _A = 25 °C, unless otherwise noted					
Parameter	Symbol	10 s	Steady State	Unit	
Drain-Source Voltage		V _{DS}	30		V
Gate-Source Voltage		V _{GS}	± 12		
Continuous Dunin Courset /T 450 00\d	T _A = 25 °C	- I _D	8	5.9	
Continuous Drain Current (T _J = 150 °C) ^a	T _A = 70 °C		6.5	4.7	
Pulsed Drain Current		I _{DM}	30		Α
Continuous Source Current (Diode Conduction) ^a		I _S	2.2	1.20	
	T _A = 25 °C	P _D	2.5	1.31	W
Maximum Power Dissipation ^a	T _A = 70 °C		1.6	0.84	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150		°C

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Mandana Landian La Andria de	t ≤ 10 s	R _{thJA}	43	50		
Maximum Junction-to-Ambient ^a	Steady State	□thJA	74	95	°C/W	
Maximum Junction-to-Foot (Drain)	Steady State	R _{thJF}	22	27		

Notes:

a. Surface Mounted on 1" x 1" FR4 board.

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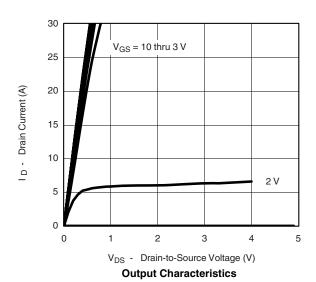
SPECIFICATIONS T _J = 25 °C, unless otherwise noted							
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250 \mu A$	0.7		2.0	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 12 V$			± 100	nA	
Zara Cata Valtaga Drain Current	lana	V _{DS} = 30 V, V _{GS} = 0 V			1	μΑ	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 30 V, V _{GS} = 0 V, T _J = 55 °C			5		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	20			Α	
		V _{GS} = 10 V, I _D = 8 A		0.019	0.023		
	D	$V_{GS} = 4.5 \text{ V}, I_D = 7.5 \text{ A}$		0.021	0.025		
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = 3.0 \text{ V}, I_D = 6.8 \text{ A}$		0.023	0.030	Ω	
		$V_{GS} = 2.5 \text{ V}, I_D = 6.0 \text{ A}$		0.027	0.036		
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 8 A		32		S	
Diode Forward Voltage ^a	V_{SD}	I _S = 2.2 A, V _{GS} = 0 V		0.75	1.1	V	
Dynamic ^b							
Total Gate Charge	Q_g			6.5	10		
Gate-Source Charge	Q_{gs}	$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 8 \text{ A}$		2.3		nC	
Gate-Drain Charge	Q_{gd}			1.1			
Gate Resistance	R_g		0.25	0.5	0.75	Ω	
Turn-On Delay Time	t _{d(on)}			9	15		
Rise Time	t _r	V_{DD} = 15 V, R_L = 15 Ω		11	17		
Turn-Off Delay Time t _{d(of}		$I_D \cong 1 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 6 \Omega$		40	60	ns	
Fall Time	t _f			7	11		
Source-Drain Reverse Recovery Time	t _{rr}	I _F = 2.2 A, dI/dt = 100 A/μs		20	35		

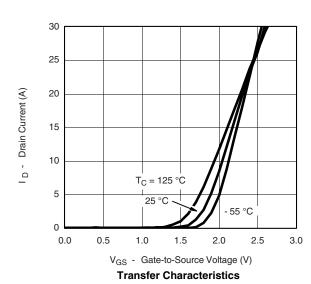
Notes:

- a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



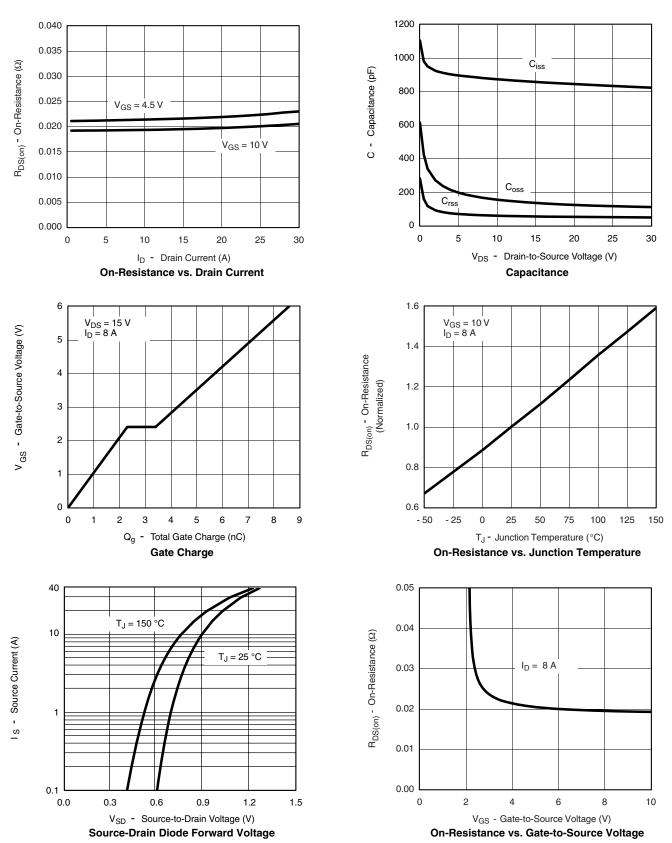








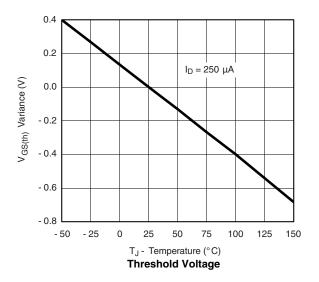
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

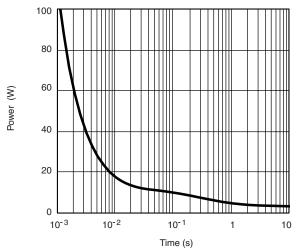


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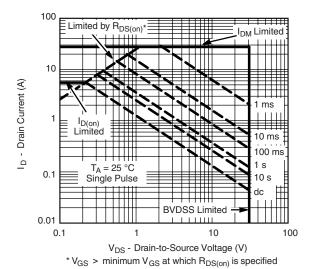
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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

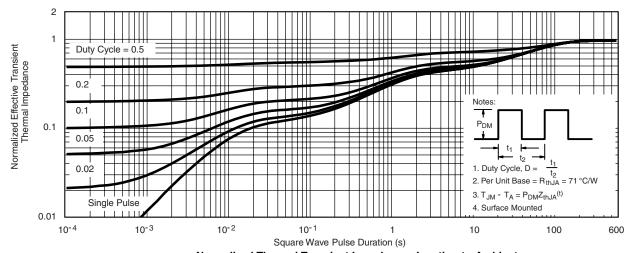




Single Pulse Power, Junction-to-Ambient



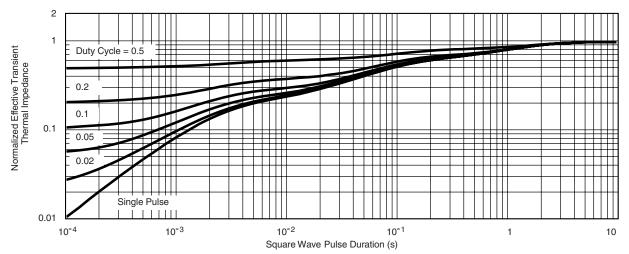
Safe Operating Area



Normalized Thermal Transient Impedance, Junction-to-Ambient



TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

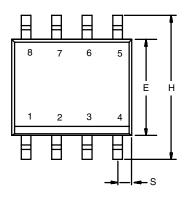


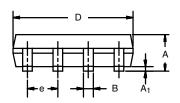
Normalized Thermal Transient Impedance, Junction-to-Foot

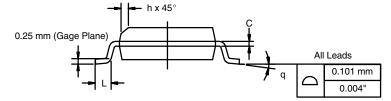
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SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012







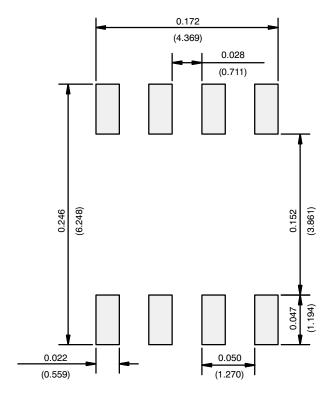
	MILLIMETERS INCHES			HES		
DIM	Min	Max	Min	Max		
Α	1.35	1.75	0.053	0.069		
A ₁	0.10	0.20	0.004	0.008		
В	0.35	0.51	0.014	0.020		
С	0.19	0.25	0.0075	0.010		
D	4.80	5.00	0.189	0.196		
Е	3.80	4.00	0.150	0.157		
е	1.27 BSC		0.050	0 BSC		
Н	5.80	6.20	0.228	0.244		
h	0.25	0.50	0.010	0.020		
L	0.50	0.93	0.020	0.037		
q	0°	8°	0°	8°		
S	0.44	0.64	0.018	0.026		
ECN: C-06527-Rev. I. 11-Sep-06						

DWG: 5498

Document Number: 71192 www.vishay.com 11-Sep-06



RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)

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